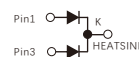


TO-263

MUR6030LD1

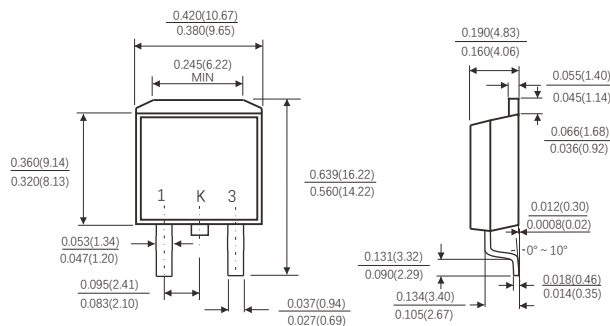
FEATURES

- Fred Chip Planar Construction
- Super Fast Switching,High Efficiency
- Low Power loss, High Efficiency
- Low Reverse Leakage Current
- High Surge Current Capability
- Plastic Material has UL Flammability Classification 94V-0



MECHANICAL DATA

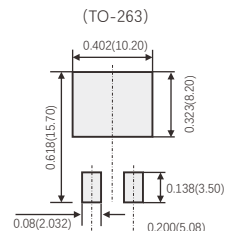
- Case: TO-263, Molded Plast
- Terminals:Pure tin Plated ,Lead free Solderable per MIL-STD-750, Method 2026
- Polarity: As marked
- Mounting Position:Any



TYPICAL APPLICATIONS

- For use in High Frequency Rectifier of Switching Mode Power Supplies, Freewheeling Diode, DC/DC Converters or polarity Protection Application

Suggested Pad Layout



(设计者可参考推荐值根据焊接工艺要求自行确定适合的焊盘尺寸)
 (Designers can refer to the recommended values according to the manufacturing process requirements to determine the appropriate pad size)

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	300	V
Maximum average forward rectified current, D=0.5, Square waveform, T _c ≤ 125°C (see Fig.1)	Per leg	30.0	A
	Total device	60.0	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated T _L , Per leg)	I _{FSM}	300	A
Operating junction temperature range	T _J	-55 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C

RATINGS AND CHARACTERISTIC OF MUR6030D1

ELECTRICAL CHARACTERISTICS (T_J=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	Min.	Typ.	Max.	Unit
Breakdown voltage Blocking voltage	I _R =200μA		V _{BR} V _R	300	-	-	V
Instaneous forward voltage	T _J =25°C	I _F =30A Per Leg	V _F ¹⁾	-	1.05	1.35	V
	T _J =125°C			-	0.90	-	
Reverse current	T _J =25°C	V _R =300V	I _R ²⁾	-	-	5	μA
	T _J =125°C			-	-	250	

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2.Pulse test: pulse width ≤40ms

DYNAMIC RECOVERY CHARACTERISTICS (T_J=25°C Unless otherwise noted)

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Reverse recovery time	I _F =0.5A, I _R =1.0A, I _{rr} =0.25A	t _{rr}	-	35	45	ns

THERMAL CHARACTERISTICS

Parameter	Symbol	TO-263	Unit
Typical thermal resistance ³⁾	R _{θJC}	1.0	°C/W

3.Thermal resistance from junction to case,Total device

RATINGS AND CHARACTERISTIC OF MUR6030D1

FIG.1-FORWARD CURRENT DERATING CURVE

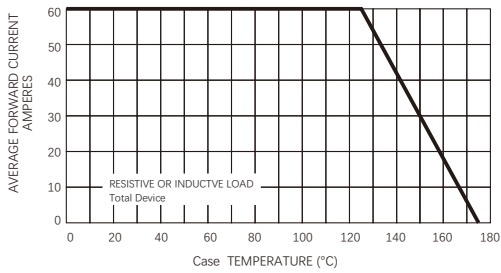


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

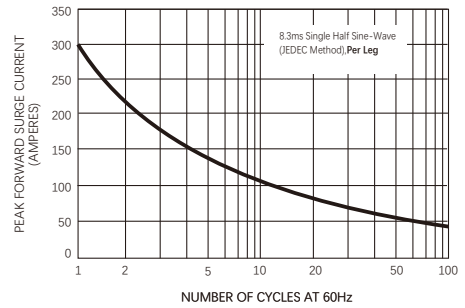


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

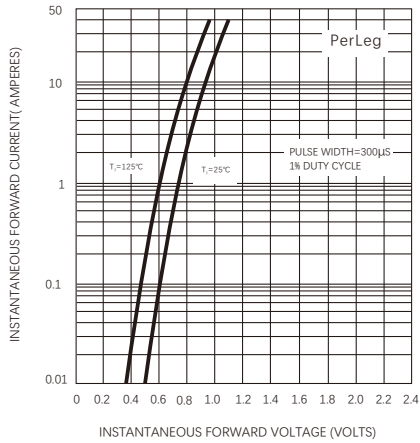


FIG.4-TYPICAL REVERSE CHARACTERISTICS

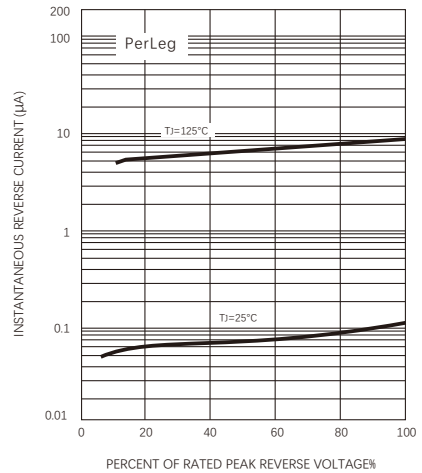


FIG.5-TYPICAL JUNCTION CAPACITANCE

